·.	Application No.	Applicant(s)	
Notice of Allowability	10/614,069		
	Examiner	BEROZ, MASUD Art Unit	
	David Nhu	2818	
The MAILING DATE of this communication appear All claims being allowable, PROSECUTION ON THE MERITS IS (herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RICOT the Office or upon petition by the applicant. See 37 CFR 1.313	or other appropriate commu	ithis application. If not includ	ed
1. This communication is responsive to 11/2/04.			
2. ☑ The allowed claim(s) is/are <u>1-24</u> .			
3. The drawings filed on <u>03 July 2003</u> are accepted by the Exa	miner.		
4. ☐ Acknowledgment is made of a claim for foreign priority und a) ☐ All b) ☐ Some* c) ☐ None of the: 1. ☐ Certified copies of the priority documents have the composition of the priority documents of the priority documents of the priority documents have the composition of the priority documents have the priority documents h	ler 35 U.S.C. § 119(a)-(d) of the communication to file and the communication to file and the communication. The communication to file and the communication to file and the communication. The communication to file and the communication to file and the communication. The communication to file and the communication to file and the communication.	in No in this national stage applicate a reply complying with the required MINER'S AMENDMENT or Not declaration is deficient.	uirements
Paper No./Mail Date Identifying indicia such as the application number (see 37 CFR 1.84 each sheet. Replacement sheet(s) should be labeled as such in the	(-W 1 144		pack) of
 DEPOSIT OF and/or INFORMATION about the deposit attached Examiner's comment regarding REQUIREMENT FO 	of BIOLOGICAL MATER		ote the
Attachment(s) . Notice of References Cited (PTO-892) . Notice of Draftperson's Patent Drawing Review (PTO-948) . Information Disclosure Statements (PTO-1449 or PTO/SB/08), Paper No./Mail Date . Examiner's Comment Regarding Requirement for Deposit of Biological Material	6. ☐ Interview Sum Paper No./Ma 7. ☐ Examiner's Ar 8. ☑ Examiner's Sta 9. ☐ Other	mal Patent Application (PTO- imary (PTO-413), all Date nendment/Comment atement of Reasons for Allowa	

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REASONS FOR ALLOWANCE

- 1. Claims 1-24 are allowed.
- 2. The following is an examiner's statement of reasons for allowance: None of the references of record teaches or suggests as cited in claims 1, 15, 22: adhering a dielectric layer to said plurality of microelectronic elements; separating a potion of said dielectric layer from a remaining portion of said dielectric layer along at least one line extending two of said plurality of microelectronic elements; removing the separated portion of said dielectric layer and at least one of said plurality of microelectronic elements adhered to said separated portion of said dielectric layer (as cited in claim 1); juxtaposing a plurality of microelectronic elements with the first major face of said dielectric layer; assembling said microelectronic elements with said dielectric layer by abutting said microelectronic elements against the first adhesive of said dielectric layer; at least partially serving said dielectric layer while maintaining the protective liner as a single piece of material so as to form a plurality of individual microelectronic units overlying said protective liner, wherein each said individual microelectronic unit includes at least one partially served potion of said dielectric layer (as cited in claim 15); juxtaposing a plurality of microelectronic elements with the first major face of said dielectric laver: assembling said microelectronic elements with said dielectric layer by abutting said microelectronic elements against the first adhesive of said dielectric layer; maintaining the protective liner as a single piece of material while dicing said wafer and at least partially severing said dielectric layer for forming a plurality of individual; microelectronic units overlying said protective liner, wherein each said individual microelectronic unit includes at least one of

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said microelectronic chips attached to an at least partially served portion of said dielectric layer

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(as cited in claim 22).

3. Any comments considered necessary by applicant must be submitted no later than the

payment of the issue fee and, to avoid processing delays, should preferably accompany the

issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons

for Allowance."

Conclusion

4. The prior art made of record and not relied upon is considered pertinent to applicant's

disclosure: DiStefano et al (5,518,964): Microelectronic Mounting with Multiple Lead

Deformation and Bonding.

5. Any inquiry concerning this communication on earlier communications from the examiner

should be directed to David Nhu, (571)272-1792. The examiner can normally be reached

on Monday-Friday from 7:30 AM to 5:00 PM.

The examiner's supervisor, David Nelms can be reached on (571)272-1787.

The fax phone number for the organization where this application or proceeding is assigned is

(703)872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should

be directed to the receptionist whose telephone number is (703) 308-0956

David Nhu 🌬

November 9, 2004

anosta

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